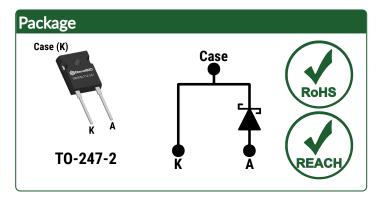
GeneSic SEMICONDUCTOR

Silicon Carbide Schottky Diode

VRRM = 1200 V IF (Tc = 135°C) = 32 A Qc = 107 nC

Features

- Low V_F for High Temperature Operation
- Enhanced Surge and Avalanche Robustness
- Superior Figure of Merit Q_C/I_F
- Low Thermal Resistance
- Low Reverse Leakage Current
- Temperature Independent Fast Switching
- Positive Temperature Coefficient of V_F
- High dV/dt Ruggedness



Advantages

- Improved System Efficiency
- High System Reliability
- Optimal Price Performance
- Reduced Cooling Requirements
- Increased System Power Density
- Zero Reverse Recovery Current
- Easy to Parallel without Thermal Runaway
- Enables Extremely Fast Switching

Applications

- Power Factor Correction (PFC)
- Electric Vehicles and Battery Chargers
- Solar Inverters
- High Frequency Converters
- Switched Mode Power Supply (SMPS)
- Motor Drives
- Anti-Parallel / Free-Wheeling Diode
- Induction Heating & Welding

Absolute Maximum Ratings (At Tc = 25°C Unless Otherwise Stated)								
Parameter	Symbol Conditions		Values	Unit	Note			
Repetitive Peak Reverse Voltage	V_{RRM}		1200	٧				
	l _F	T _C = 100°C, D = 1	46					
Continuous Forward Current		$T_C = 135^{\circ}C, D = 1$	32	Α	Fig. 4			
		$T_C = 157^{\circ}C, D = 1$	20					
Non-Repetitive Peak Forward Surge Current, Half Sine	I	$T_C = 25^{\circ}C$, $t_P = 10 \text{ ms}$	200	٨				
Wave	I _{F,SM}	$T_C = 150$ °C, $t_P = 10$ ms	160	Α				
Denotitive Deals Farmand Commo Commont Half Cine Ways	I _{F,RM}	$T_C = 25^{\circ}C$, $t_P = 10 \text{ ms}$	120	٨				
Repetitive Peak Forward Surge Current, Half Sine Wave		$T_C = 150^{\circ}C$, $t_P = 10 \text{ ms}$	84	Α				
Non-Repetitive Peak Forward Surge Current	I _{F,MAX}	T _C = 25°C, t _P = 10 μs	1000	Α				
i ² t Value	∫i²dt	$T_C = 25^{\circ}C$, $t_P = 10 \text{ ms}$	200	A ² s				
Non-Repetitive Avalanche Energy	Eas	L = 1.8 mH, I _{AS} = 20 A	360	mJ				
Diode Ruggedness	dV/dt	V _R = 0 ~ 960 V	200	V/ns				
Power Dissipation	Ртот	T _C = 25°C	312	W	Fig. 3			
Operating and Storage Temperature	T _j , T _{stg}		-55 to 175	°C				



Electrical Characteristics								
Parameter	Symbol	Conditions		Values			Unit	Note
	Зушьог			Min.	Typ.	Max.	Oilit	Note
Diode Forward Voltage	V_{F}	$I_F = 20 \text{ A, } T_j = 25^{\circ}\text{C}$			1.5	1.8	V	Fig. 1
	VF	I _F = 20 A, T _j = 175°C			1.9			
Reverse Current	I-	V _R = 1200 V, T _j = 25°C			2	10	μA	Fig. 2
	I _R	$V_R = 1200 \text{ V, T}_j = 175^{\circ}\text{C}$			22			
Total Capacitive Charge	0		V _R = 400 V		74		nC	Fig. 7
	Qc	_ l _F ≤ l _{F,MAX} dl _F /dt = 200 A/μs	$V_{R} = 800 V$		107			
Switching Time			V _R = 400 V		. 10		20	
	ts		$V_{R} = 800 V$		< 10		ns	
Total Capacitance	0	V_R = 1 V, f = 1MHz V_R = 800 V, f = 1MHz			1218		"r	Fig. 6
	C				71		pF 	

Thermal/Package Characteristics							
Parameter	Symbol	Conditions		Values			Note
		Colluitions	Min.	Тур.	Max.	- Unit	Note
Thermal Resistance, Junction - Case	R_{thJC}			0.48		°C/W	Fig. 9
Weight	W _T			6.0		g	
Mounting Torque	T _M	Screws to Heatsink			1.1	Nm	





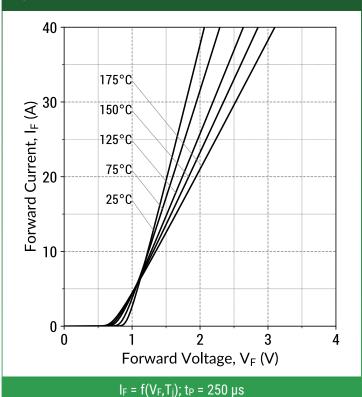
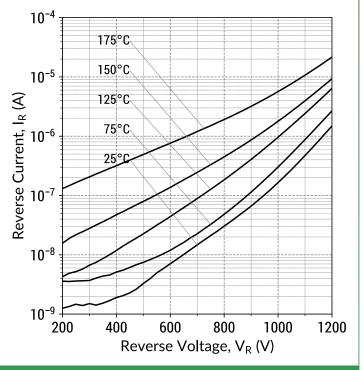


Figure 2: Typical Reverse Characteristics



 $I_R = f(V_R, T_j)$

Figure 3: Power Derating Curves

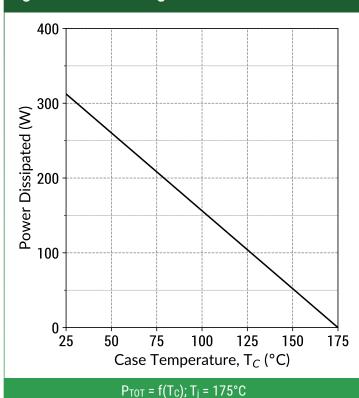


Figure 4: Current Derating Curves (Typical V_F)

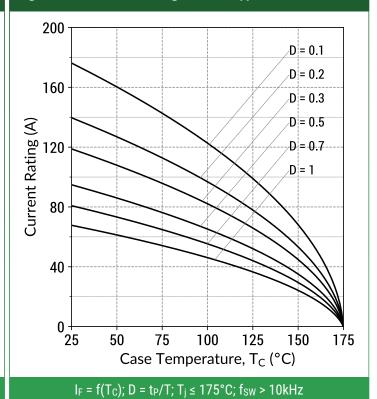
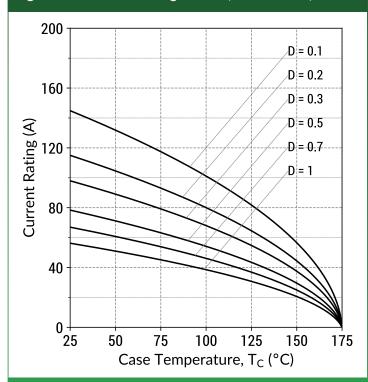


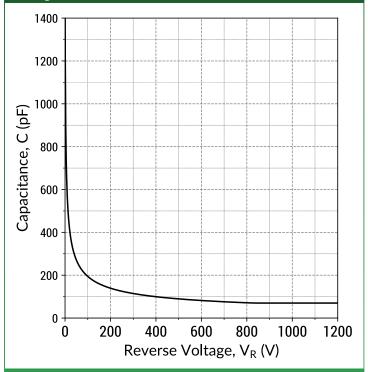


Figure 5: Current Derating Curves (Maximum V_F)



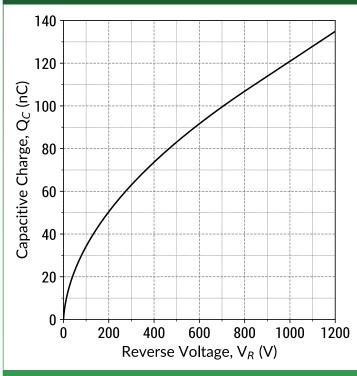
 $I_F = f(T_C); D = t_P/T; T_j \le 175^{\circ}C; f_{SW} > 10kHz$

Figure 6: Typical Junction Capacitance vs Reverse Voltage Characteristics



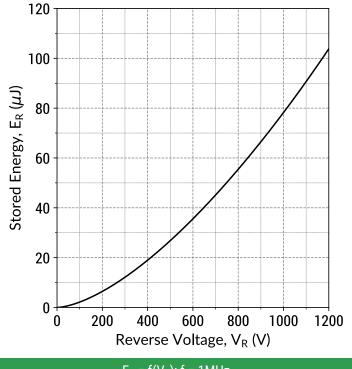
 $C = f(V_R)$; f = 1MHz

Figure 7: Typical Capacitive Charge vs Reverse Voltage Characteristics



 $Q_C = f(V_R)$; f = 1MHz

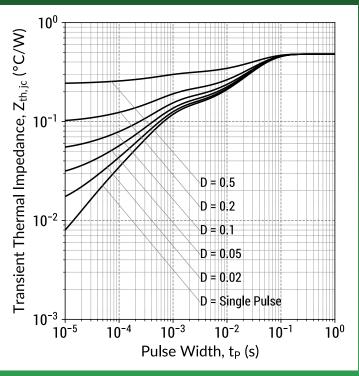
Figure 8: Typical Capacitive Energy vs Reverse Voltage Characteristics



 $E_C = f(V_R)$; f = 1MHz

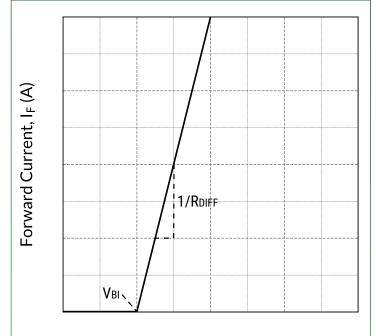


Figure 9: Transient Thermal Impedance



 $Z_{th,jc} = f(t_P,D); D = t_P/T$

Figure 10: Forward Curve Model



Forward Voltage, $V_F(V)$

 $I_F = f(V_F, T_j)$

Forward Curve Model Equation:

 $I_F = (V_F - V_{BI})/R_{DIFF}(A)$

Built-In Voltage (V_{BI}):

$$V_{BI}(T_j) = m \times T_j + n (V)$$

 $m = -0.00123 (V/^{\circ}C)$
 $n = 0.995 (V)$

Differential Resistance (RDIFF):

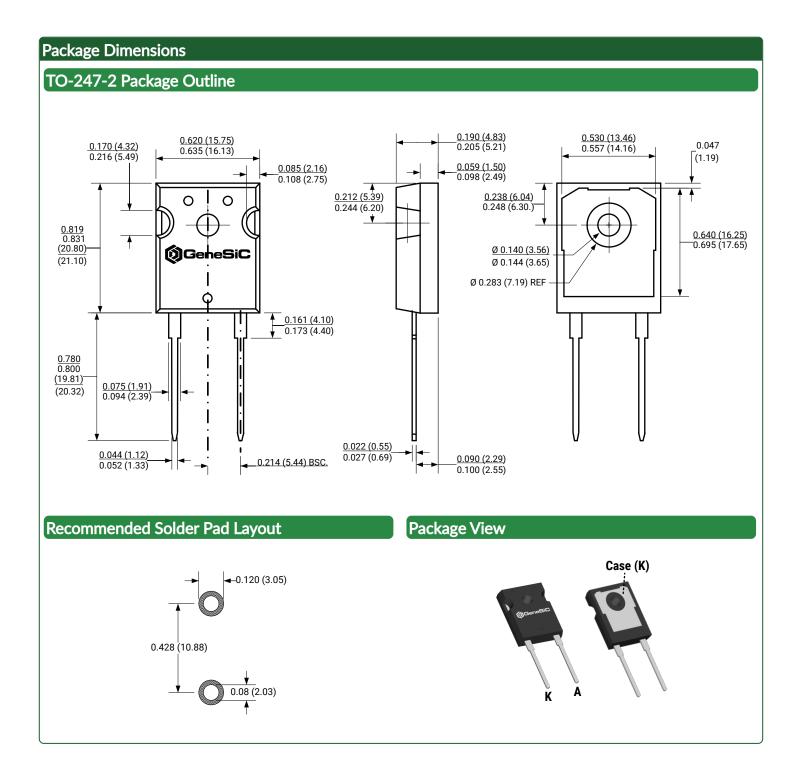
$$R_{DIFF}(T_j) = a \times T_j^2 + b \times T_j + c (\Omega)$$

 $a = 5.96e-07 (\Omega/^{\circ}C^2)$
 $b = 8.46e-05 (\Omega/^{\circ}C)$
 $c = 0.0251 (\Omega)$

Forward Power Loss Equation:

$$P_{LOSS} = V_{BI}(T_j) \times I_{AVG} + R_{DIFF}(T_j) \times I_{RMS}^2$$





NOTE

- 1. CONTROLLED DEIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
- 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS.





RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS 2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863. RoHS Declarations for this product can be obtained from your GeneSiC representative.

REACH Compliance

REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a GeneSiC representative to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

This product has not been designed or tested for use in, and is not intended for use in, applications implanted into the human body nor in applications in which failure of the product could lead to death, personal injury or property damage, including but not limited to equipment used in the operation of nuclear facilities, life-support machines, cardiac defibrillators or similar emergency medical equipment, aircraft navigation or communication or control systems, or air traffic control systems.

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